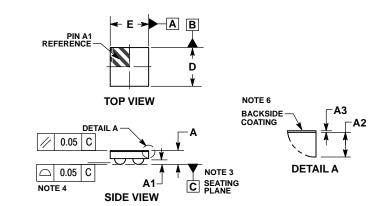
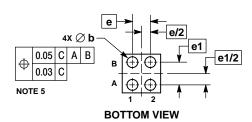


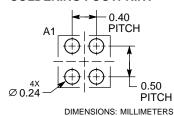
WLCSP4, 0.85x0.85x0.3 CASE 567PP ISSUE O

DATE 11 AUG 2016





RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 1 14.3W, 1994.
 2 CONTROLLING DIMENSION: MILLIMETERS.
 3. DATUM C, THE SEATING PLANE, IS DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
 4. COPLANARITY APPLIES TO THE SPHERICAL
- CROWNS OF THE SOLDER BALLS.

 5. DIMENSION 6 IS MEASURED AT THE MAXIMUM CONTACT BALL DIAMETER PARALLEL TO DATUM C.
- 6. BACKSIDE COATING IS OPTIONAL.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α			0.30	
A1	0.09	0.11	0.13	
A2	0.14 REF			
A3	0.025 REF			
b	0.22	0.24	0.26	
D	0.83	0.85	0.87	
E	0.83	0.85	0.87	
е	0.40 BSC			
e1	0.50 BSC			

GENERIC MARKING DIAGRAM*



Х = Specific Device Code

= Year

W = Work Week

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator. "G" or microdot " ■". may or may not be present.

DESCRIPTION:	WLCSP4, 0.85X0.85X0.3	PAGE 1 OF 2
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